PROGRAMMING

The Am27LS18 and Am27LS19 are manufactured with a conductive Platinum-Silicide link at each bit location. The output of the memory with the link in place is LOW. To program the device, the fusible links are selectively opened.

The fusible links are opened one at a time by passing current through them from a 20 volt supply which is applied to one memory output after the $\overline{CS}$ input is at a logic HIGH. Current is gated through the addressed fuse by raising the $\overline{CS}$ input from a logic HIGH to 15 volts. After 50 μsec, the 20 volt supply is removed, the chip enabled, and the output level sensed to determine if the link has opened. Most links will open within 50 μsec. Occasionally a link will be stronger and require additional programming cycles. The recommended duration of additional programming periods is 5 msec. If a link has not opened after a total elapsed programming time of 400 msec, further programming of the device should not be attempted. Successive links are programmed in the same manner until all desired bit locations have been programmed to the HIGH level.

Typical current into an output during programming will be approximately 140mA until the fuse link is opened, after which the current drops to approximately 40mA. Current into the $\overline{CS}$ pin when it is raised to 15 volts is typically 1.5mA.

The memories may become hot during programming due to the large currents being passed. Programming cycles should not be applied to one device more than 5 seconds to avoid heat damage. If this programming time is exceeded, all power to the chip including V_{CC} should be removed for a period of 5 seconds after which programming may be resumed.

When all programming has been completed, the data content of the memory should be verified by sequentially reading all words. Occasionally this verification will show that an extra undesired link has been fused. Should this occur, immediately check the programming equipment to make sure that all device pins are firmly contacting the programming socket, that the input signal levels exhibit sufficient noise margins, and that the programming voltages are within the specified limits. All of these conditions must be maintained during programming. AMD PROMs are thoroughly tested to minimize unwanted fusing; fusing extra bits is generally related to programming equipment problems.

PROGRAMMING PARAMETERS

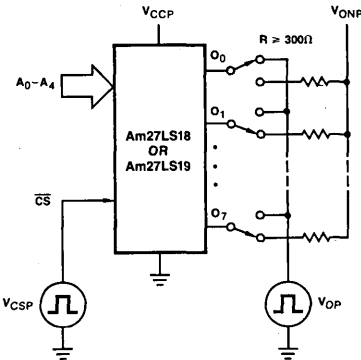| Parameter	Description	Min.	Max.	Units
V_{CCP}	V_{CC} During Programming	5.0	5.5	Volts
V_{IHP}	Input HIGH Level During Programming	2.4	5.5	Volts
V_{ILP}	Input LOW Level During Programming	0.0	0.45	Volts
V_{CSP}	$\overline{CS}$ Voltage During Programming	14.5	15.5	Volts
V_{OP}	Output Voltage During Programming	19.5	20.5	Volts
V_{ONP}	Voltage on Outputs Not to be Programmed	0	$V_{CCP}+0.3$	Volts
I_{ONP}	Current into Outputs Not to be Programmed		20	mA
$d(V_{OP})/dt$	Rate of Output Voltage Change	20	250	V/μsec
$d(V_{CS})/dt$	Rate of $\overline{CS}$ Voltage Change	100	1000	V/μsec
t_P	Programming Period — First Attempt	50	100	μsec
	Programming Period — Subsequent Attempts	5.0	15	msec

Notes: 1. All delays between edges are specified from completion of the first edge to beginning of the second edge; i.e., not to the midpoints.
2. Delays t_1, t_2, t_3 and t_4 must be greater than 100 ns; maximum delays of 1 μsec are recommended to minimize heating during programming.
3. During t_V, a user defined period, the output being programmed is switched to the load R and read to determine if additional pulses are required.
4. Outputs not being programmed are connected to V_{ONP} through resistor R which provides output current limiting.

PROGRAMMING WAVEFORMS
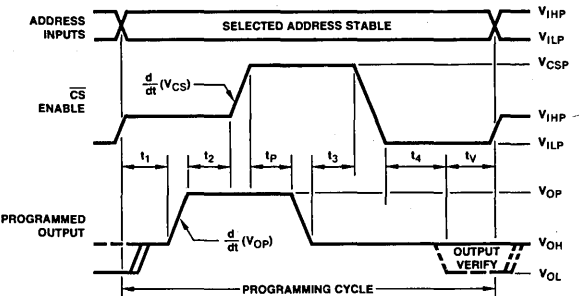
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SIMPLIFIED PROGRAMMING DIAGRAM

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